

TOSHIBA Bipolar Digital Integrated Circuit Silicon Monolithic

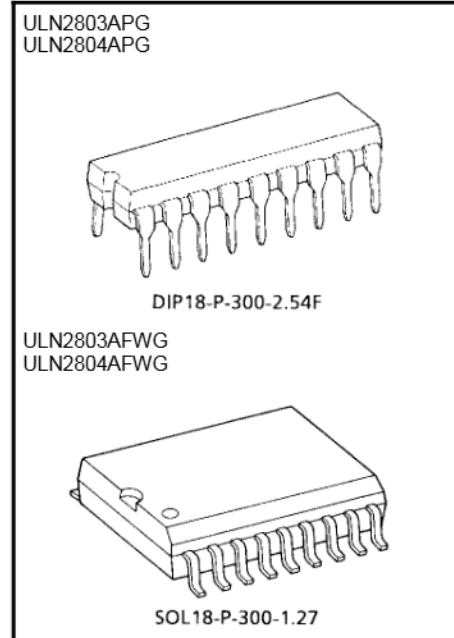
ULN2803APG,ULN2803AFWG,ULN2804APG,ULN2804AFWG (Manufactured by Toshiba Malaysia)

8ch Darlington Sink Driver

The ULN2803APG / AFWG Series are high-voltage, high-current darlington drivers comprised of eight NPN darlington pairs.
All units feature integral clamp diodes for switching inductive loads.
Applications include relay, hammer, lamp and display (LED) drivers.
The suffix (G) appended to the part number represents a Lead (Pb)-Free product.

Features

- Output current (single output)
500 mA (Max.)
- High sustaining voltage output
50 V (Min.)
- Output clamp diodes
- Inputs compatible with various types of logic.
- Package Type-APG : DIP-18pin
- Package Type-AFWG : SOL-18pin

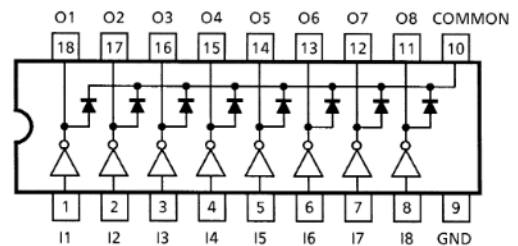


Weight

DIP18-P-300-2.54F: 1.478 g (Typ.)
SOL18-P-300-1.27 : 0.48 g (Typ.)

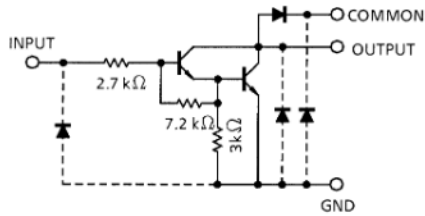
Type	Input Base Resistor	Designation
ULN2803APG / AFWG	2.7 k Ω	TTL, 5 V CMOS
ULN2804APG / AFWG	10.5 k Ω	6~15 V PMOS, CMOS

Pin Connection (top view)

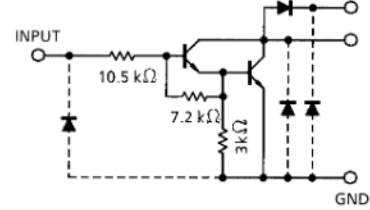


Schematics (each driver)

ULN2803APG / AFWG



ULN2804APG / AFWG



Note: The input and output parasitic diodes cannot be used as clamp diodes.

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Output sustaining voltage		$V_{CE(SUS)}$	-0.5~50	V
Output current		I_{OUT}	500	mA / ch
Input voltage		V_{IN}	-0.5~30	V
Clamp diode reverse voltage		V_R	50	V
Clamp diode forward current		I_F	500	mA
Power dissipation	APG	P_D	1.47	W
	AFWG		0.92 / 1.31 (Note)	
Operating temperature		T_{opr}	-40~85	°C
Storage temperature		T_{stg}	-55~150	°C

Note: On Glass Epoxy PCB (75 × 114 × 1.6 mm Cu 20%)

Recommended Operating Conditions (Ta = -40~85°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Output sustaining voltage		V _{CE (SUS)}		0	—	50	V
Output current	APG	I _{OUT}	T _{pw} = 25 ms, Duty = 10%, 8 Circuits	0	—	347	mA / ch
			T _{pw} = 25 ms, Duty = 50%, 8 Circuits	0	—	123	
	AFWG		T _{pw} = 25 ms, Duty = 10%, 8 Circuits	0	—	268	
			T _{pw} = 25 ms, Duty = 50%, 8 Circuits	0	—	90	
Input voltage		V _{IN}		0	—	30	V
Input voltage (Output on)	ULN2803A	V _{IN (ON)}		3.5	—	30	V
	ULN2804A			8	—	30	
Clamp diode reverse voltage		V _R		—	—	50	V
Clamp diode forward current		I _F		—	—	400	mA
Power dissipation	APG	P _D	Ta = 85°C	—	—	0.76	W
	AFWG		Ta = 85°C (Note)	—	—	0.48	

Note: On Glass Epoxy PCB (75 × 114 × 1.6 mm Cu 20%)

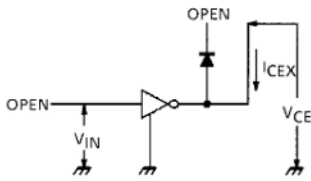
Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Cir-Cuit	Test Condition	Min	Typ.	Max	Unit
Output leakage current ULN2804A	I_{CEX}	1	$V_{CE} = 50\text{ V}$ $T_a = 25^\circ\text{C}$	—	—	50	μA
			$V_{CE} = 50\text{ V}$ $T_a = 85^\circ\text{C}$	—	—	100	
			$V_{CE} = 50\text{ V}$ $V_{IN} = 1\text{ V}$	—	—	500	
Collector-emitter saturation voltage	$V_{CE}(\text{sat})$	2	$I_{OUT} = 350\text{ mA}$, $I_{IN} = 500\text{ }\mu\text{A}$	—	1.3	1.6	V
			$I_{OUT} = 200\text{ mA}$, $I_{IN} = 350\text{ }\mu\text{A}$	—	1.1	1.3	
			$I_{OUT} = 100\text{ mA}$, $I_{IN} = 250\text{ }\mu\text{A}$	—	0.9	1.1	
Input current ULN2803A ULN2804A	$I_{IN}(\text{ON})$	2	$V_{IN} = 3.85\text{ V}$	—	0.93	1.35	mA
			$V_{IN} = 5\text{ V}$	—	0.35	0.5	
			$V_{IN} = 12\text{ V}$	—	1.0	1.45	
	$I_{IN}(\text{OFF})$	4	$I_{OUT} = 500\text{ }\mu\text{A}$, $T_a = 85^\circ\text{C}$	50	65	—	μA
Input voltage (Output on) ULN2803A ULN2804A	$V_{IN}(\text{ON})$	5	$V_{CE} = 2\text{ V}$, $I_{OUT} = 200\text{ mA}$	—	—	2.4	V
			$V_{CE} = 2\text{ V}$, $I_{OUT} = 250\text{ mA}$	—	—	2.7	
			$V_{CE} = 2\text{ V}$, $I_{OUT} = 300\text{ mA}$	—	—	3.0	
			$V_{CE} = 2\text{ V}$, $I_{OUT} = 125\text{ mA}$	—	—	5.0	
			$V_{CE} = 2\text{ V}$, $I_{OUT} = 200\text{ mA}$	—	—	6.0	
			$V_{CE} = 2\text{ V}$, $I_{OUT} = 275\text{ mA}$	—	—	7.0	
			$V_{CE} = 2\text{ V}$, $I_{OUT} = 350\text{ mA}$	—	—	8.0	
DC current transfer ratio	h_{FE}	2	$V_{CE} = 2\text{ V}$, $I_{OUT} = 350\text{ mA}$	1000	—	—	
Clamp diode reverse current	I_R	6	$T_a = 25^\circ\text{C}$ (Note)	—	—	50	μA
			$T_a = 85^\circ\text{C}$ (Note)	—	—	100	
Clamp diode forward voltage	V_F	7	$I_F = 350\text{ mA}$	—	—	2.0	V
Input capacitance	C_{IN}	—		—	15	—	pF
Turn-on delay	t_{ON}	8	$R_L = 125\text{ }\Omega$, $V_{OUT} = 50\text{ V}$	—	0.1	—	μs
Turn-off delay	t_{OFF}		$R_L = 125\text{ }\Omega$, $V_{OUT} = 50\text{ V}$	—	0.2	—	

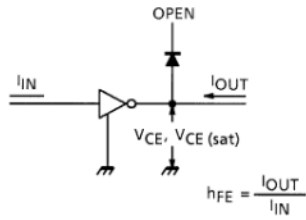
 Note: $V_R = V_R \text{ MAX.}$

Test Circuit

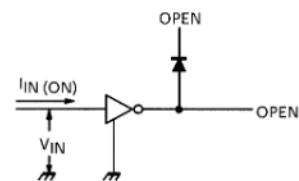
1. I_{CEX}



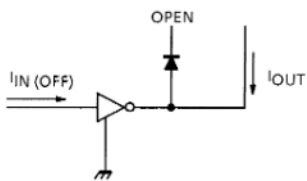
2. $V_{CE(sat)}$, h_{FE}



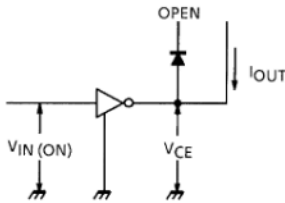
3. $I_{IN(ON)}$



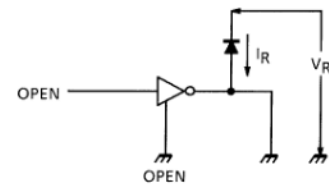
4. $I_{IN(OFF)}$



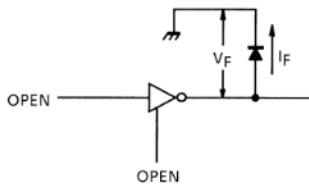
5. $V_{IN(ON)}$



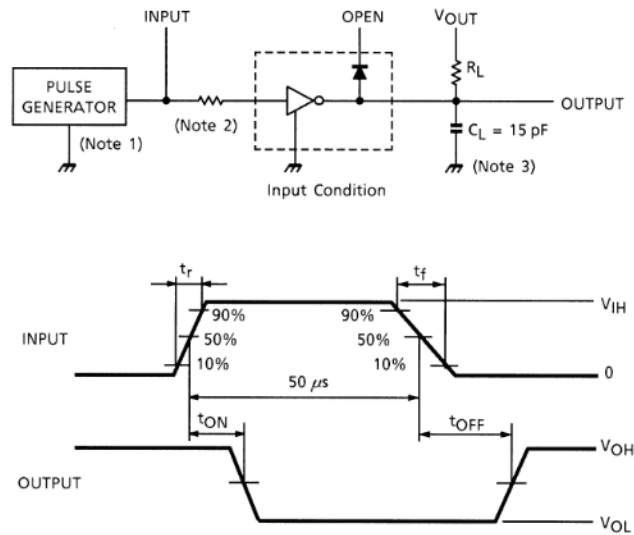
6. I_R



7. V_F



8. t_{ON} , t_{OFF}



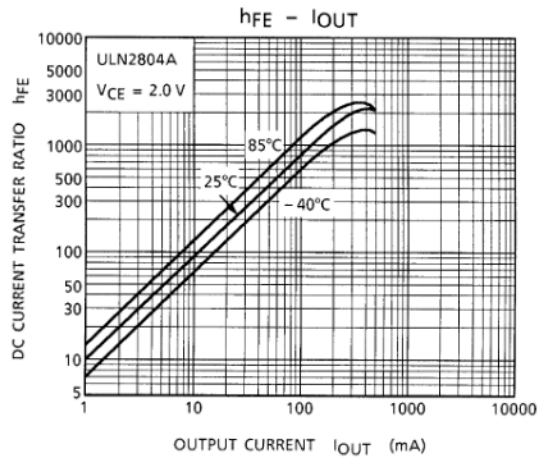
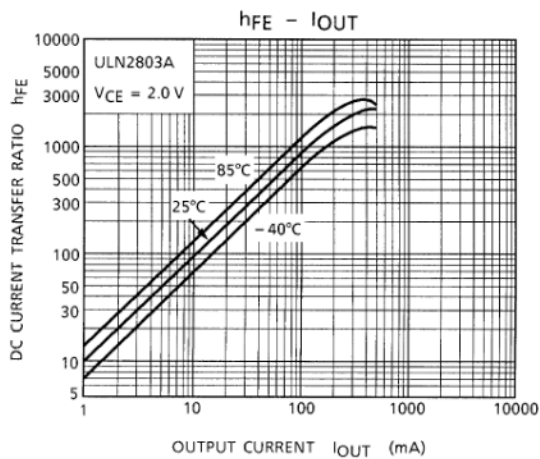
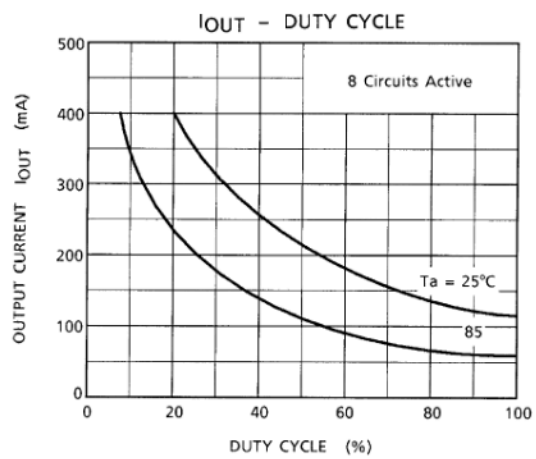
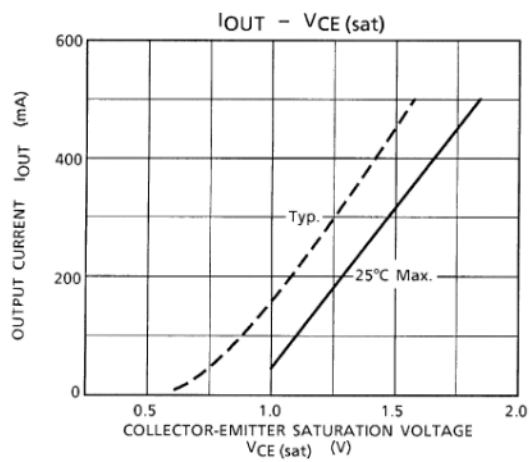
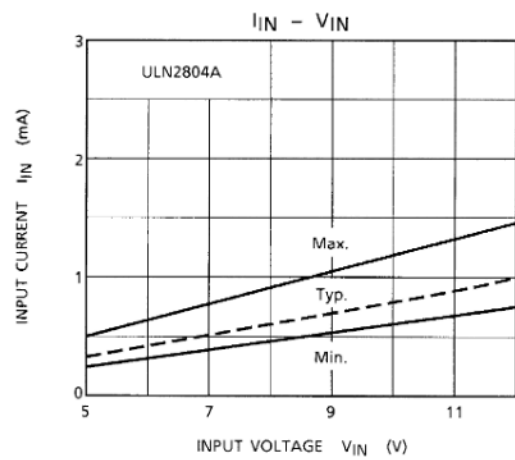
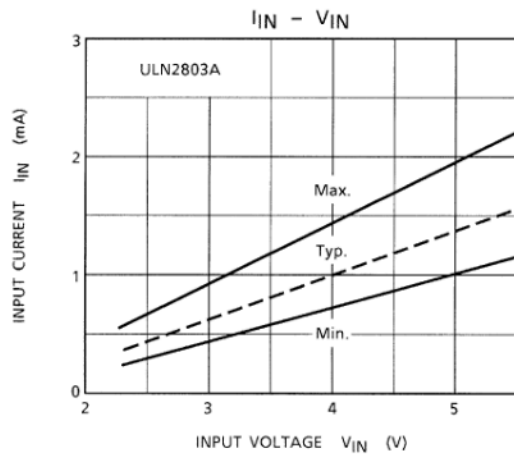
Note 1: Pulse Width 50 μ s, Duty Cycle 10%
Output Impedance 50 Ω , $t_r \leq 5$ ns, $t_f \leq 10$ ns
Note 2: See below.

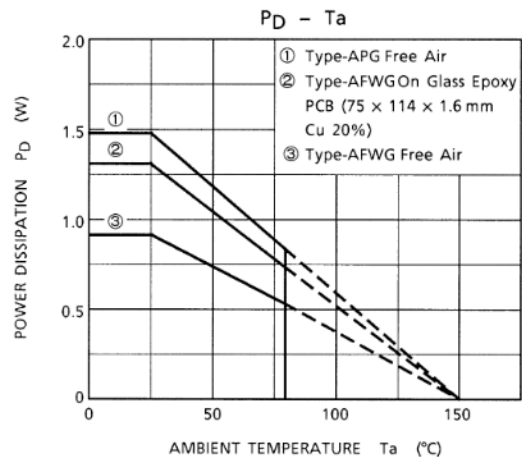
Input Condition		
Type Number	R1	V_{IH}
ULN2803A	0 Ω	3 V
ULN2804A	0 Ω	8 V

Note 3: C_L includes probe and jig capacitance

Precautions for Using

This IC does not integrate protection circuits such as overcurrent and overvoltage protectors. Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC. Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

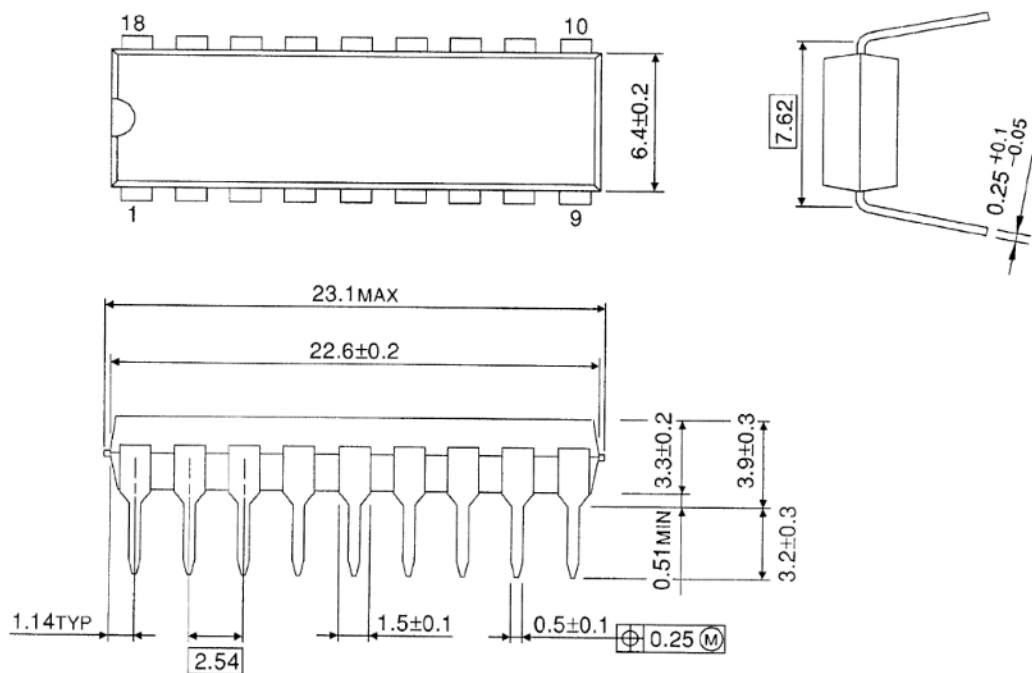




Package Dimensions

DIP18-P-300-2.54F

Unit: mm

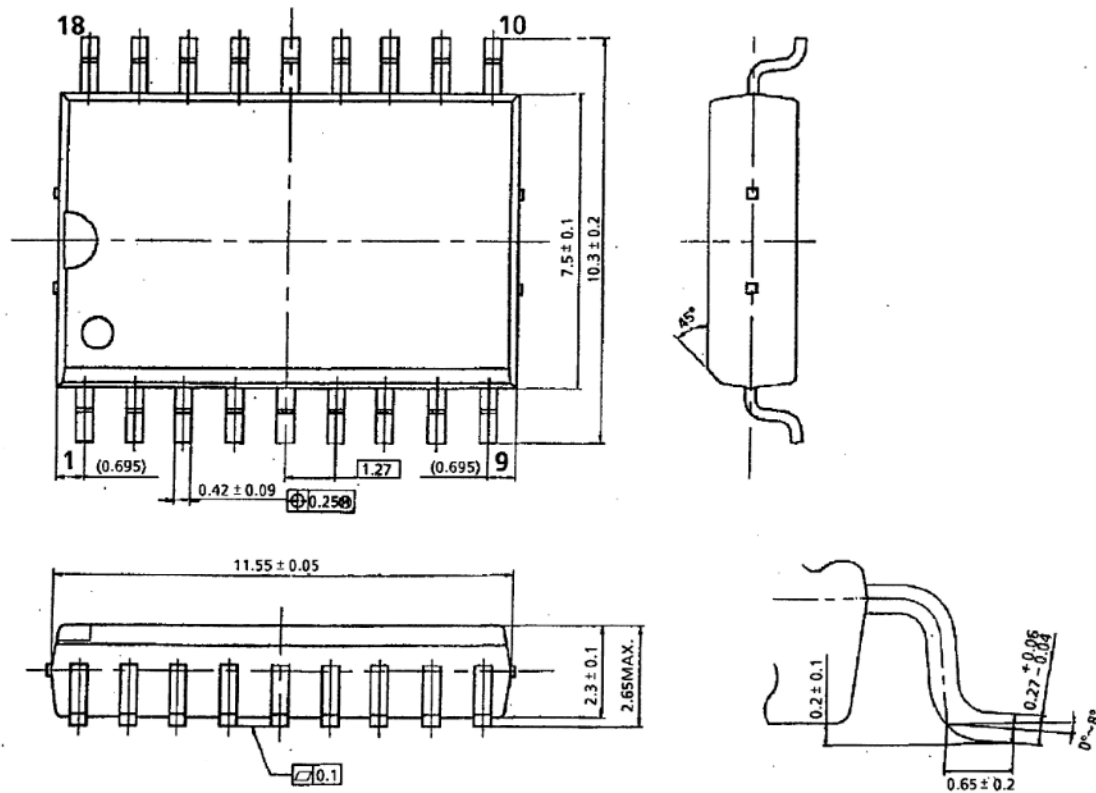


Weight: 1.478 g (Typ.)

Package Dimensions

SOL18-P-300-1.27

Unit: mm



Weight: 0.48 g (Typ.)

Notes on Contents**1. Schematics**

The schematics may be simplified or some parts of them may be omitted for explanatory purposes.

2. Absolute Maximum Ratings

The absolute maximum ratings of a semiconductor device are a set of specified parameter values that must not be exceeded during operation, even for an instant.

If any of these ratings are exceeded during operation, the electrical characteristics of the device may be irreparably altered and the reliability and lifetime of the device can no longer be guaranteed.

Moreover, any exceeding of the ratings during operation may cause breakdown, damage and/or degradation in other equipment. Applications using the device should be designed so that no absolute maximum rating will ever be exceeded under any operating conditions.

Before using, creating and/or producing designs, refer to and comply with the precautions and conditions set forth in this document.

3. Recommended Operating Conditions

The values of the conditions are applied within the range of the operating temperature and not guaranteed.

4. AC Characteristics

AC characteristics that mean turn-on and turn-off time are targeted design values and not guaranteed.

5. Application Circuits

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially in the phase of mass production design.

In furnishing these examples of application circuits, Toshiba does not grant the use of any industrial property rights.

6. Graphics Characteristics

Graphics characteristics are reference ones and not guaranteed.

Handling of the IC

Ensure that the product is installed correctly to prevent breakdown, damage and/or degradation in the product or equipment.

About solderability, following conditions were confirmed

- Solderability

- (1) Use of Sn-37Pb solder Bath

- solder bath temperature = 230°C
 - dipping time = 5 seconds
 - the number of times = once
 - use of R-type flux

- (2) Use of Sn-3.0Ag-0.5Cu solder Bath

- solder bath temperature = 245°C
 - dipping time = 5 seconds
 - the number of times = once
 - use of R-type flux

RESTRICTIONS ON PRODUCT USE

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In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc. 021023_A
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